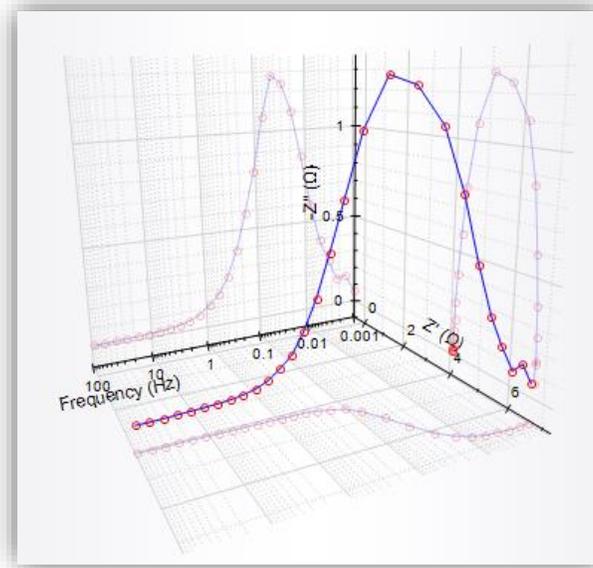


Applications of impedance spectroscopy in thermoelectricity



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Outline

1. Introduction to the impedance method
2. Equivalent circuits for thermoelectricity
3. Module characterisation
4. Convection heat transfer coefficient determination
5. Thermal contact resistance determination
6. Acknowledgements



1. Introduction to the impedance method

Why exploring impedance in thermoelectrics?

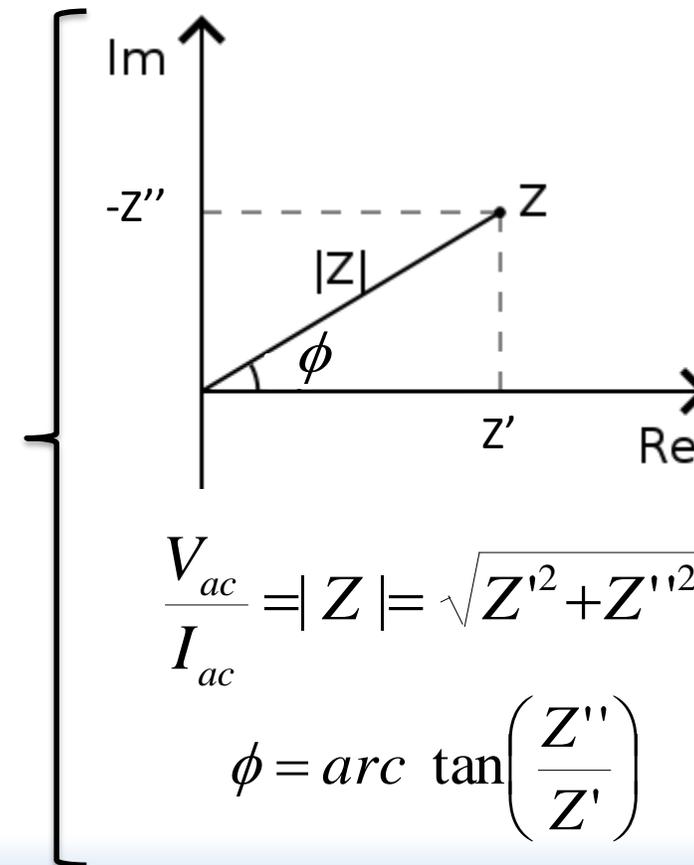
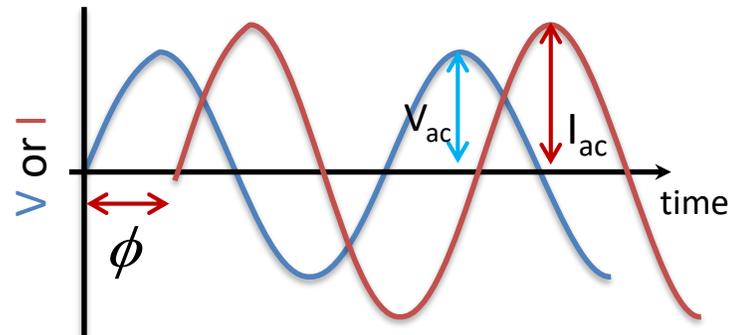
- It is **widely used** in a lot of different fields (solar cells, fuel cells, corrosion, supercapacitors, batteries, etc.).
- Powerful and very **reliable equipment** are **available in the market**.
- It allows the **separation** of the **physical processes** occurring in a device.



1. Introduction to the impedance method

The perturbation and the system response

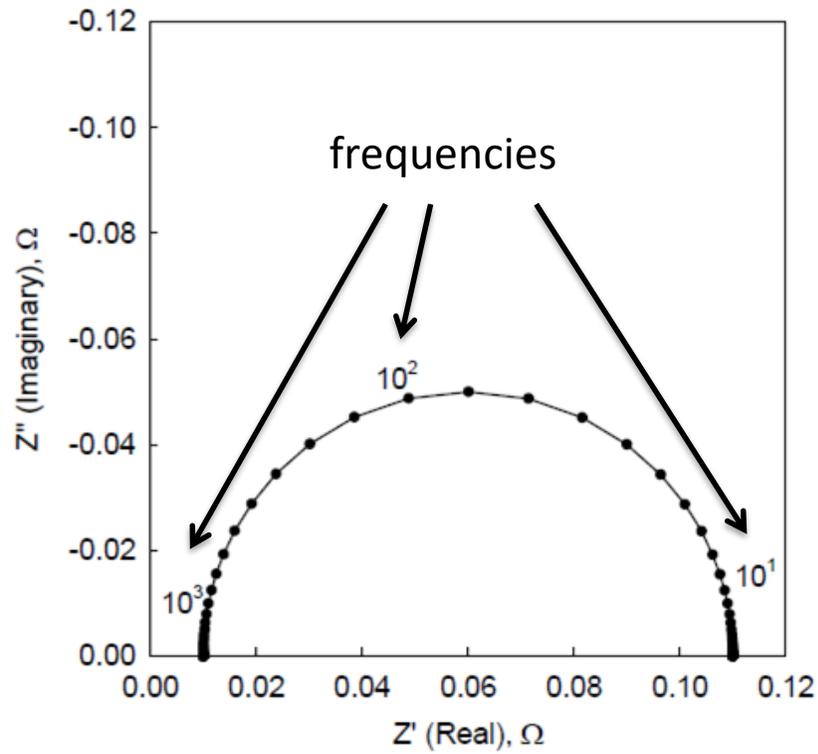
- A **small amplitude sinusoidal current wave** of a certain frequency is applied
- The system responds with a **voltage wave proportional** to the current that can be shifted in time (phase)



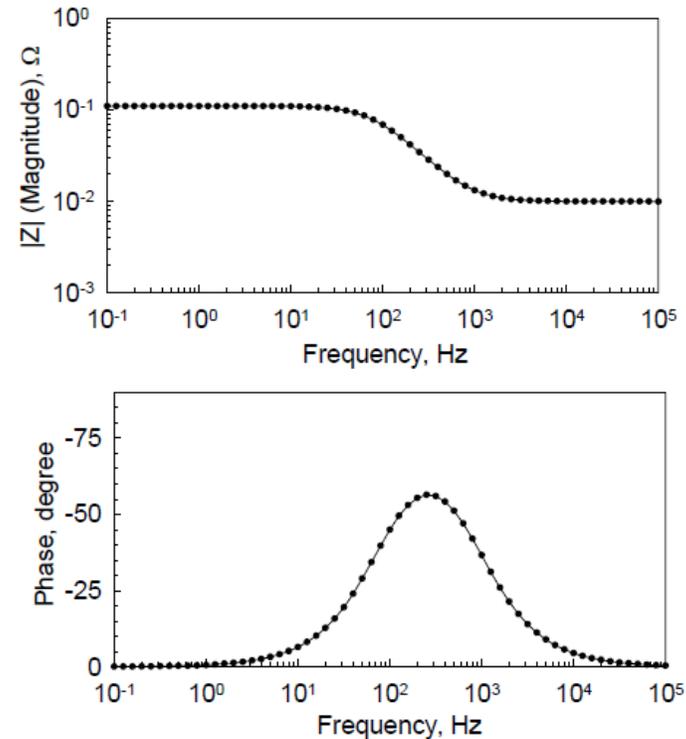
1. Introduction to the impedance method

The impedance spectrum

Z is obtained for a wide **range of frequencies** (e. g. 1 MHz to 10 mHz), obtaining one point in the spectrum per each frequency.



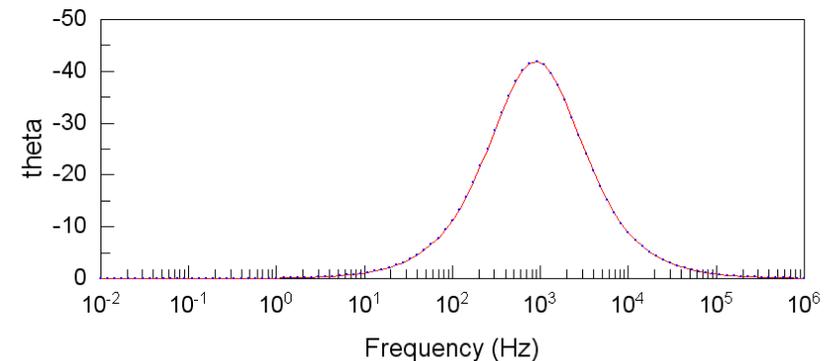
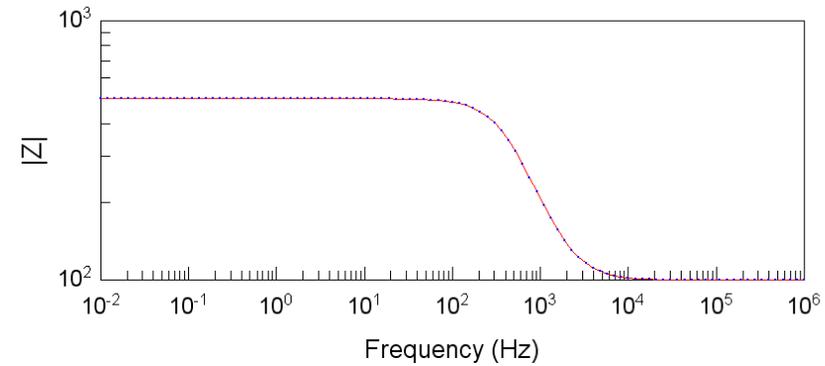
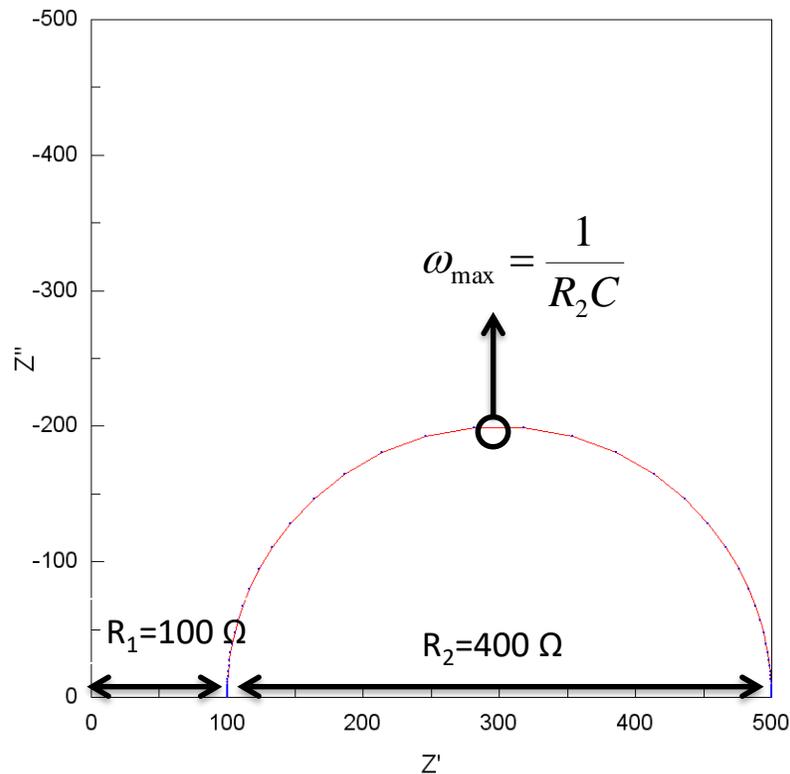
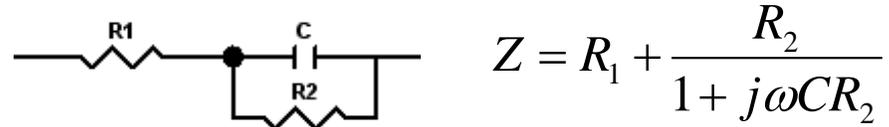
Impedance spectrum (Nyquist plot)



Parameters vs frequency (Bode plots)

1. Introduction to the impedance method

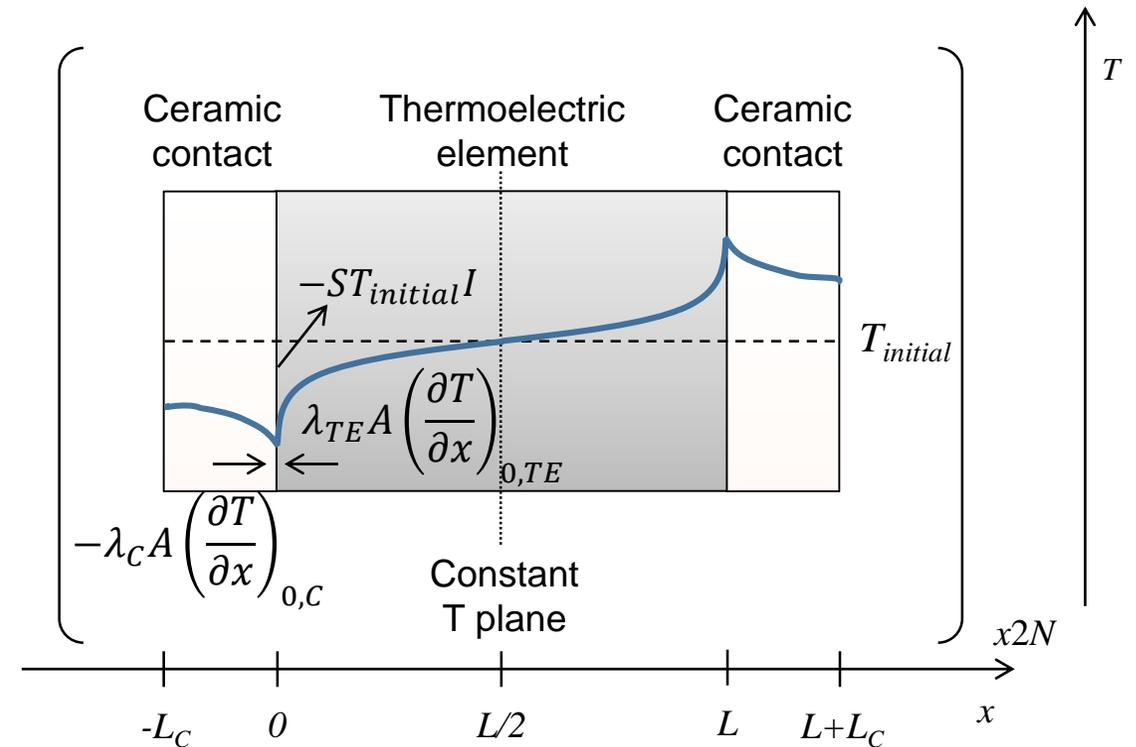
Equivalent circuits



2. Equivalent circuits in thermoelectricity

Model considerations

- **Module of $2N$ thermoelements with the typical architecture.**
- **Adiabatic conditions** (no heat exchanged with surroundings), i.e. suspended module in vacuum.
- All thermal and TE **parameters independent on temperature.**
- System is **initially at thermal equilibrium** at temperature $T_{initial}$.
- **Joule effect is neglected** both in the bulk and at the junctions.
- **Spreading-constriction** effects due to differences in areas between legs and ceramics is discarded.
- Thermal influence of the **Cu contacts is neglected.**



2. Equivalent circuits in thermoelectricity

Impedance function

$$V = IR_{\Omega} + S[T(L) - T(0)]$$

$$Z(t) = \frac{V}{I} = R_{\Omega} + \frac{S[T(L) - T(0)]}{I}$$

time domain (t)

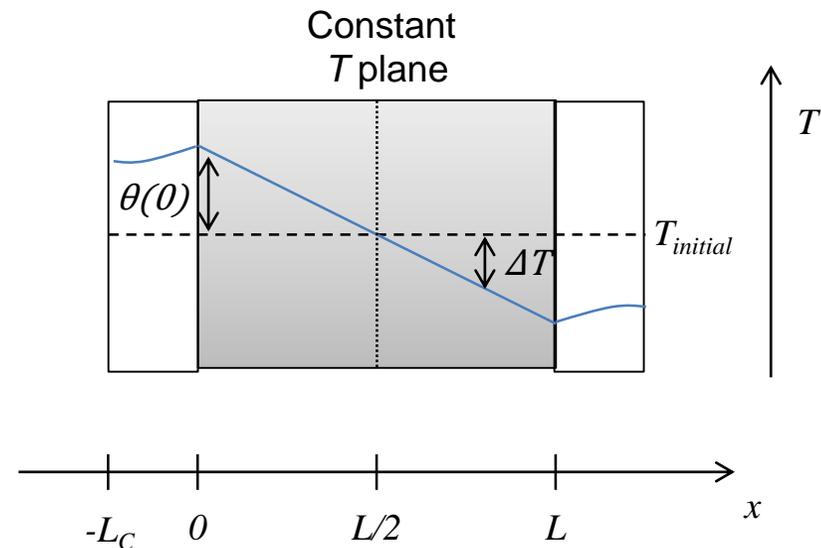
$$\begin{array}{l} \mathcal{L}\{\Delta T\} = \theta \quad \mathcal{L}\{I\} = i_0 \\ \xrightarrow{\hspace{1cm}} \\ [T(L) - T(0)] \rightarrow -2\theta(0) \end{array}$$

$$Z(j\omega) = R_{\Omega} - \frac{S2\theta(0)}{i_0}$$

frequency domain (j ω)

To know the impedance function we **need to know the T difference** at $x=0$ as a function of frequency

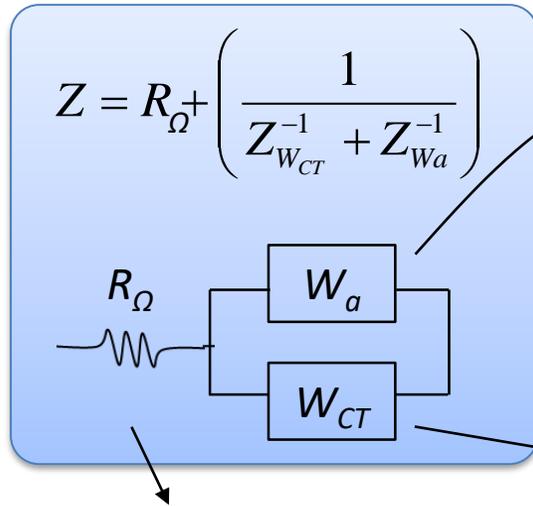
Solve heat equation



$V = V(0) - V(L)$, R_{Ω} = total ohmic resistance, $\omega = 2\pi f$, f is the frequency, $j = \sqrt{-1}$

2. Equivalent circuits in thermoelectricity

Equivalent circuit elements



R_{Ω} is the total ohmic resistance

$$R_{\Omega} = 2N\rho \frac{L}{A} + R_{parasitic}$$

W_{CT} is a Constant T Warburg

$$Z_{W_{CT}} = R_{TE} \left(\frac{j\omega}{\omega_{TE}} \right)^{-0.5} \tanh \left\{ \left(\frac{j\omega}{\omega_{TE}} \right)^{0.5} \right\}$$

$$R_{TE} = 2N \frac{S^2 T_{initial} L}{\lambda_{TE} A}$$

Thermoelectric resistance

$$\omega_{TE} = \frac{\alpha_{TE}}{(L/2)^2}$$

Characteristic frequency

W_a is an adiabatic Warburg

$$Z_{W_a} = R_C \left(\frac{j\omega}{\omega_C} \right)^{-0.5} \coth \left\{ \left(\frac{j\omega}{\omega_C} \right)^{0.5} \right\}$$

$$R_C = 4N \frac{S^2 T_{initial} L_C}{\lambda_C A}$$

Thermoelectric resistance from ceramic

$$\omega_C = \frac{\alpha_C}{(L_C)^2}$$

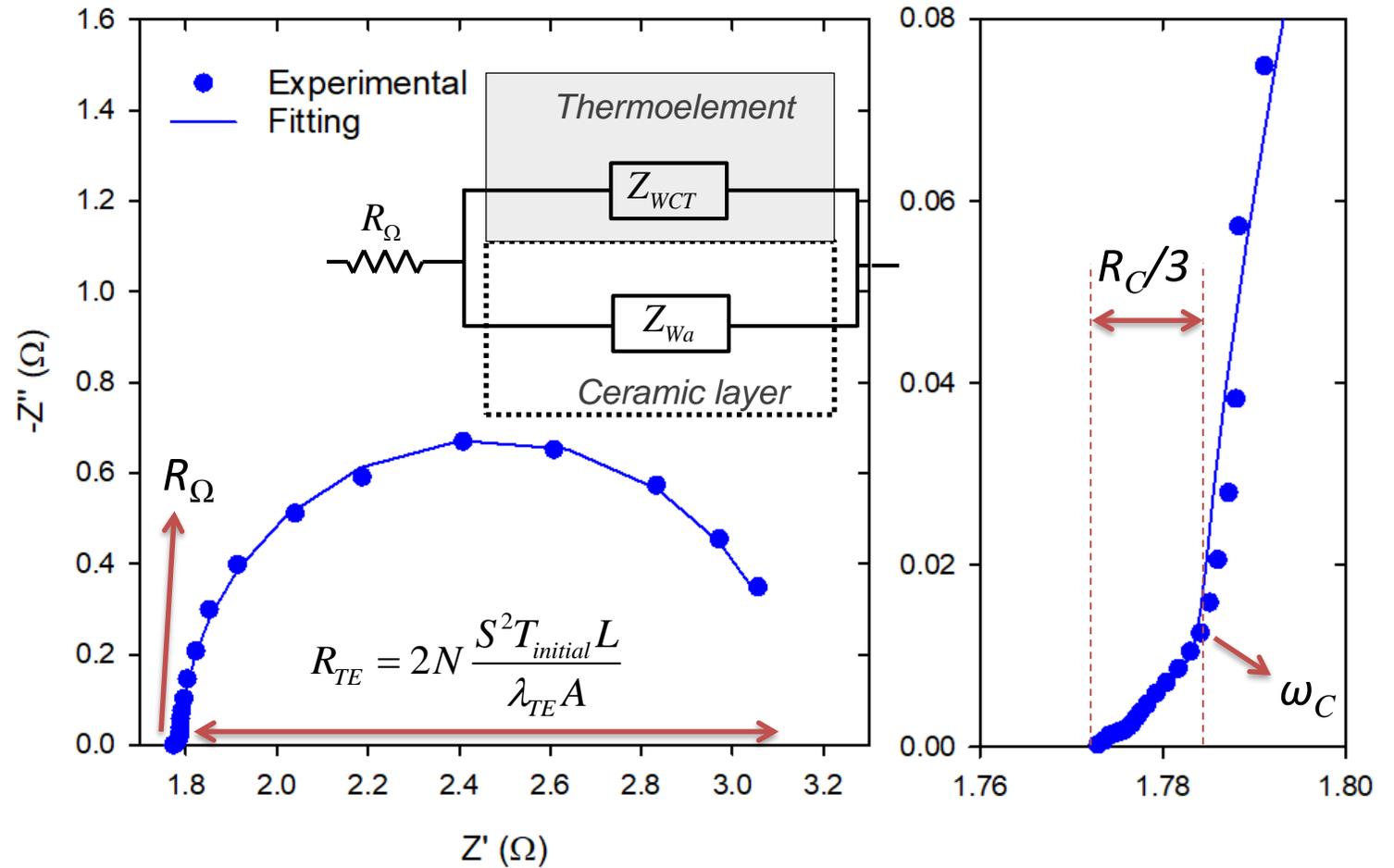
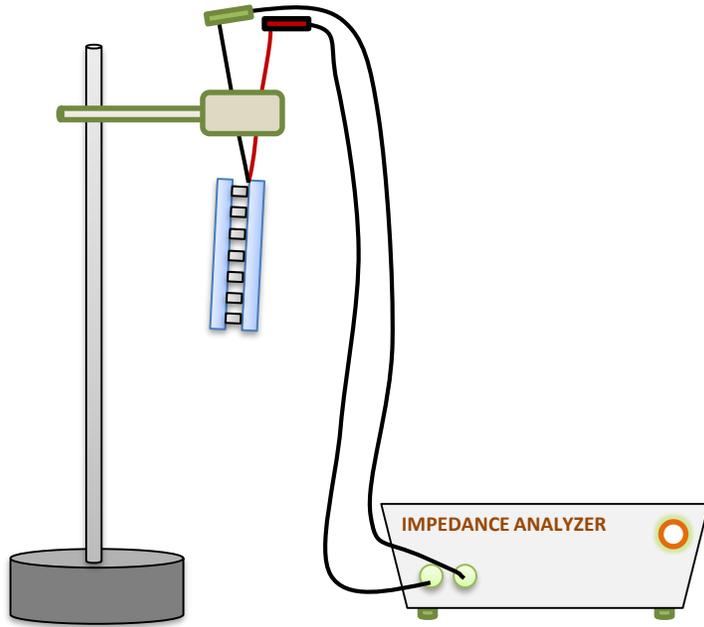
Characteristic frequency from ceramic

The **fitting** of experimental measurements to the equivalent circuit **provides**: R_{Ω} , R_{TE} , ω_{TE} , R_C and ω_C . The resistances contain all the **interesting TE properties** (S and λ of the legs and the R_{Ω} of the module).

From the thermoelement: S =Seebeck coefficient, ρ =electrical resistivity, α_{TE} =thermal diffusivity, λ_{TE} =thermal conductivity
 From the contact: α_C =thermal diffusivity, λ_C =thermal conductivity

3. Module characterisation

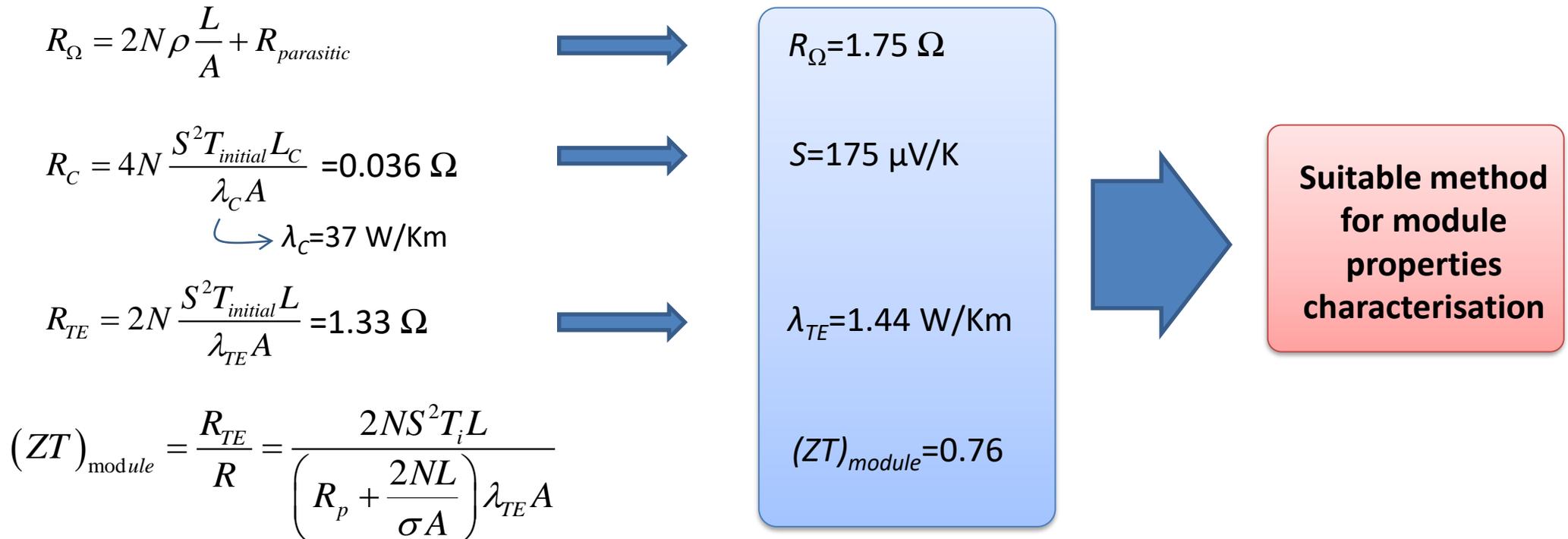
Bi-Te commercial module suspended in vacuum ($<10^{-4}$ mbar) at room T



Extracted parameters

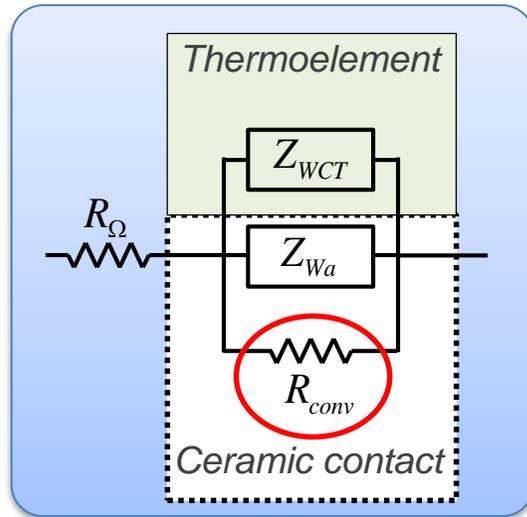
The **Seebeck coefficient and thermal conductivity** can be **extracted** if the **thermal conductivity of the ceramic is known**. The **module internal resistance** and the **ZT** can be **directly** extracted.

All properties show **good agreement** with values of the manufacturer.



4. Convection heat transfer coefficient determination

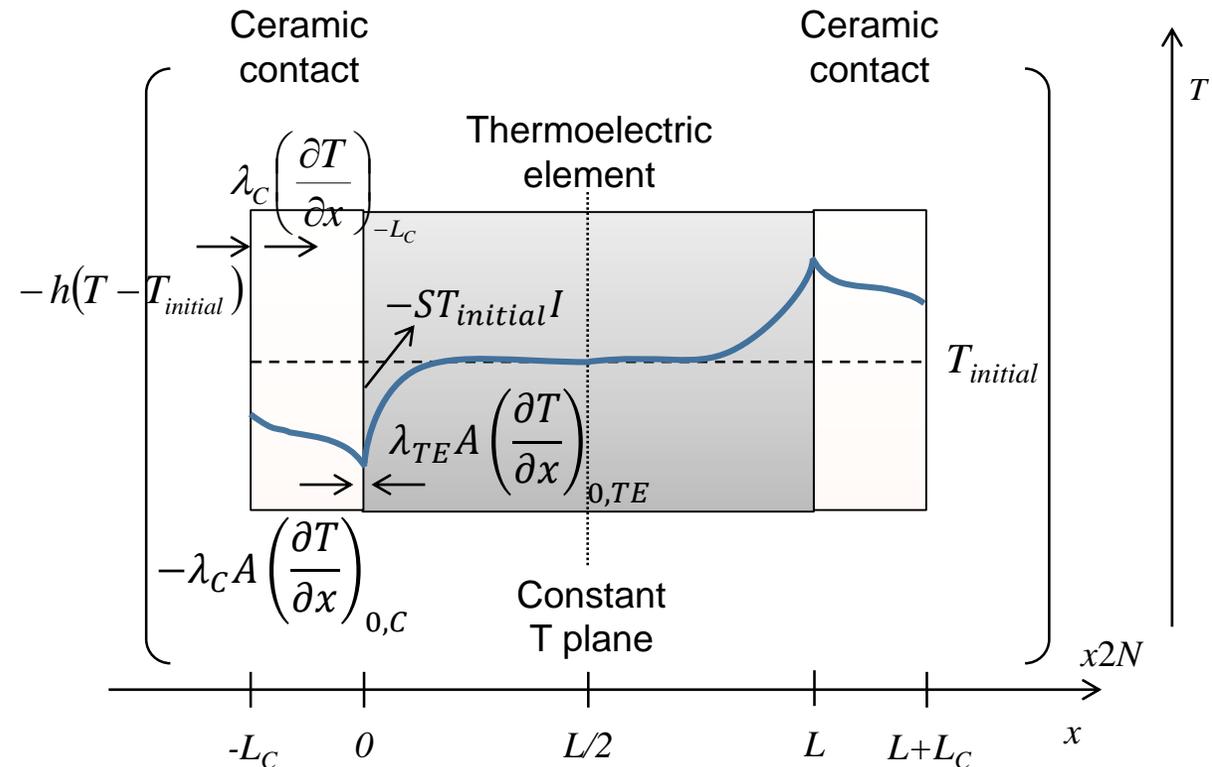
Model considerations



$$R_{conv} = 4N \frac{S^2 T_{initial} \eta}{hA}$$

h =convection heat transfer coefficient

η =Total area of TE legs/ceramic plate area



4. Convection heat transfer coefficient determination

Extracted parameters

The **convection resistance** can be **obtained** from a fitting to the suspended module in vacuum and other fitting in air (or the condition to be evaluated). From R_{conv} , **h can be obtained** if S is known.

$$R_{conv} = 4N \frac{S^2 T_{initial} \eta}{hA} = 21.75 \Omega$$

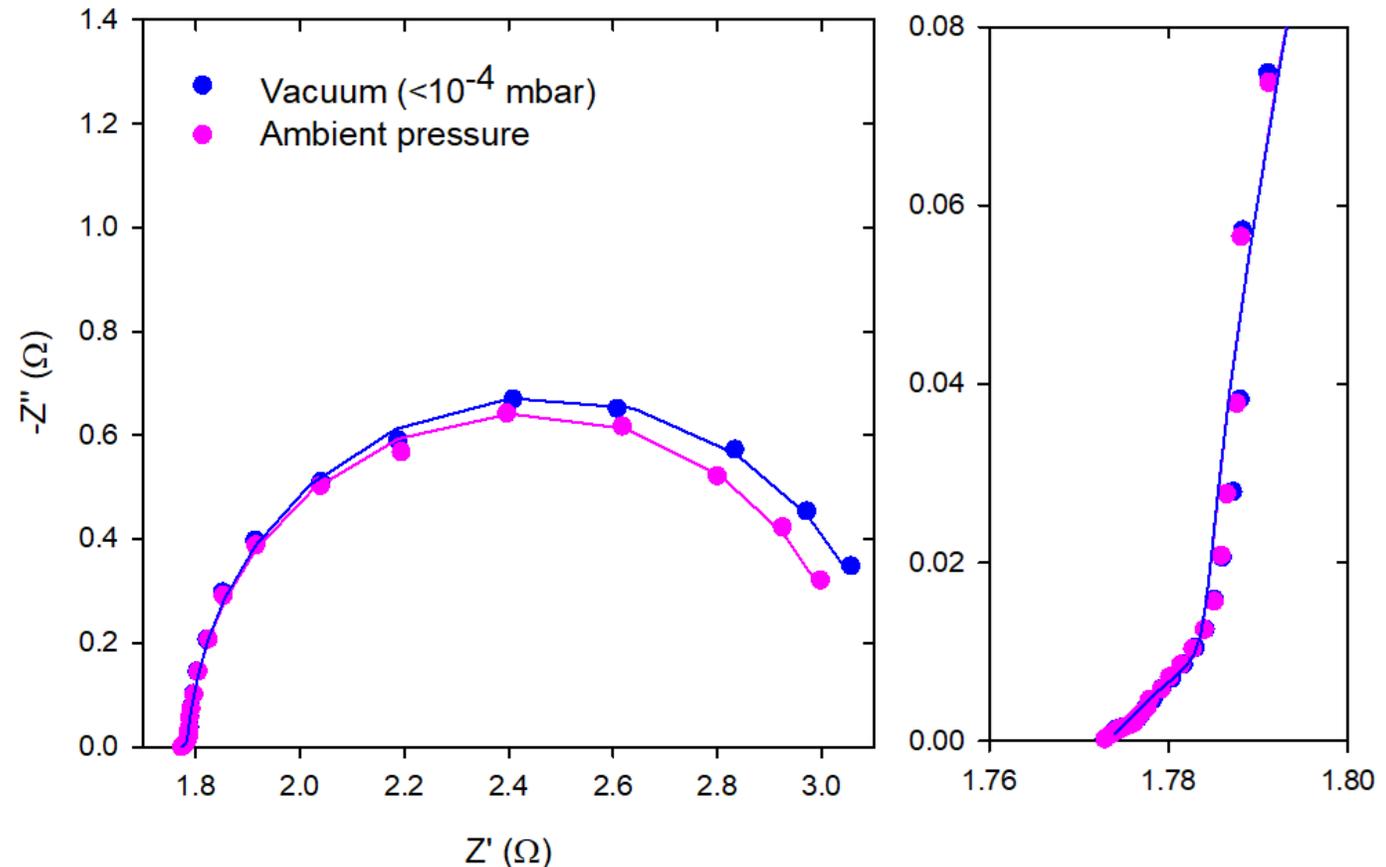
$S=192 \mu\text{V/K}$



$$h=40.12 \text{ W}/(\text{m}^2\text{K})$$

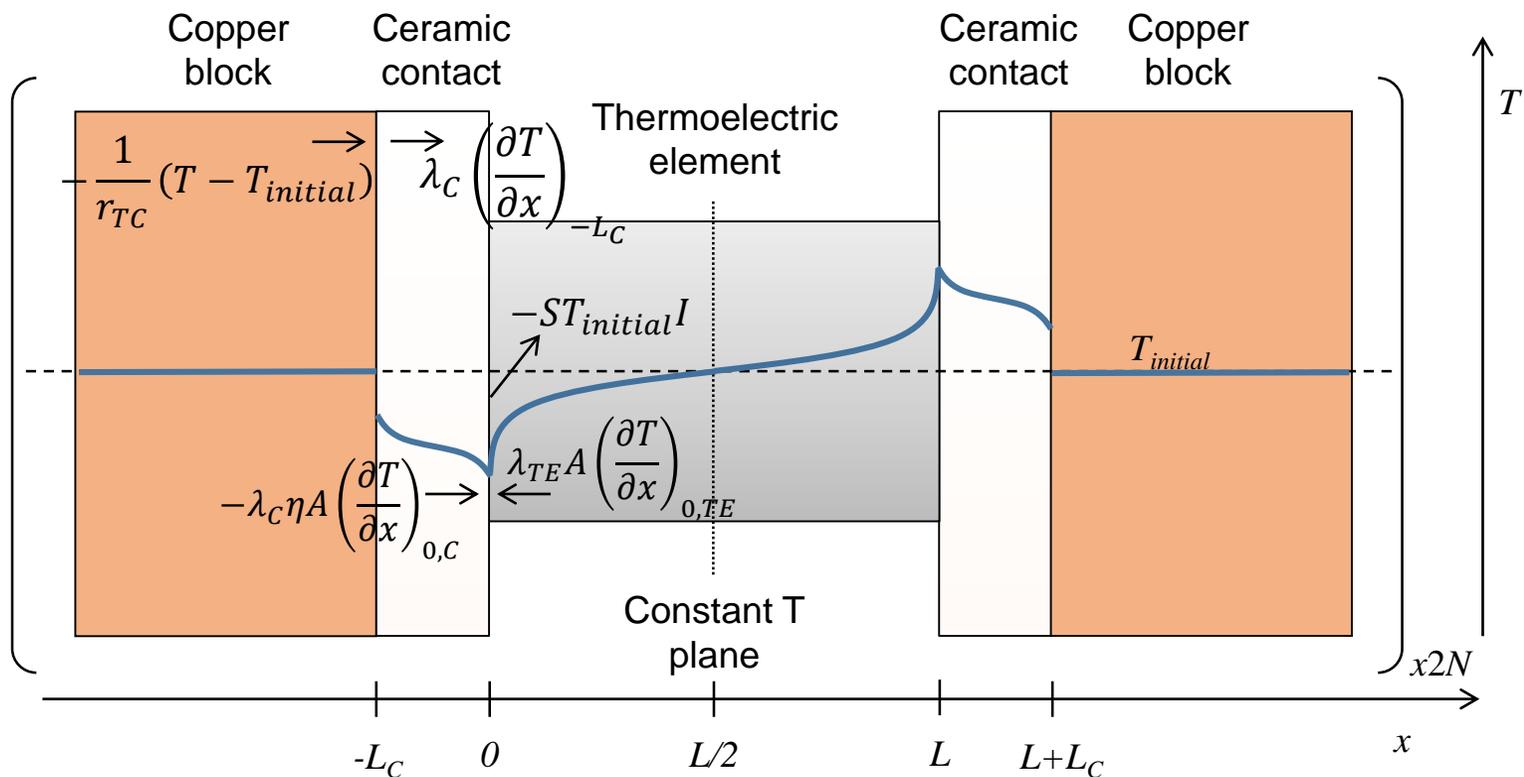
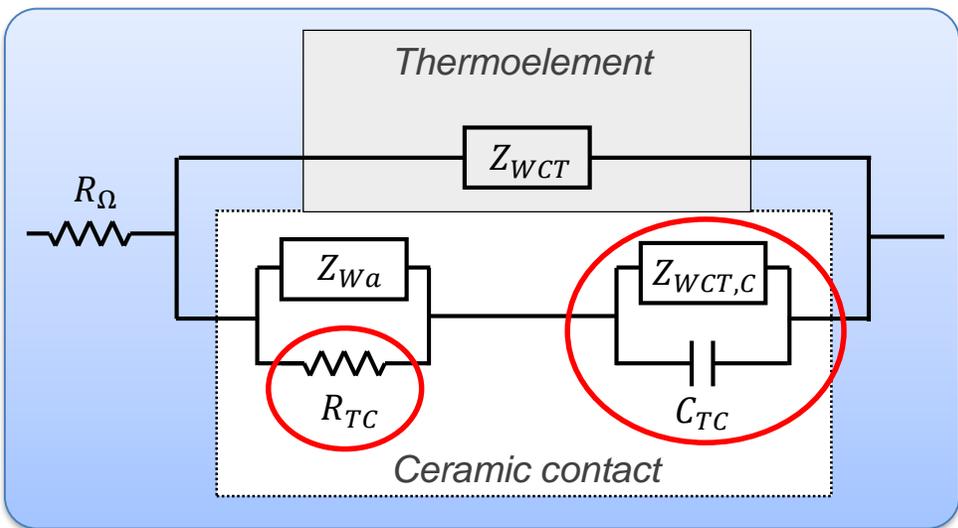
Similar order of magnitude as natural convection 5-25 $\text{W}/(\text{m}^2\text{K})$. Potential **h sensor application.**

Higher accuracy [21.6 $\text{W}/(\text{m}^2\text{K})$] was reached considering spreading-constriction effects [see Mesalam et al. Applied Energy 226 (2018) 1208]



5. Thermal contact resistance determination

Model considerations



$$R_{TC} = \frac{4NS^2 T_{initial} r_{TC} \eta}{A}$$

Thermal contact resistance

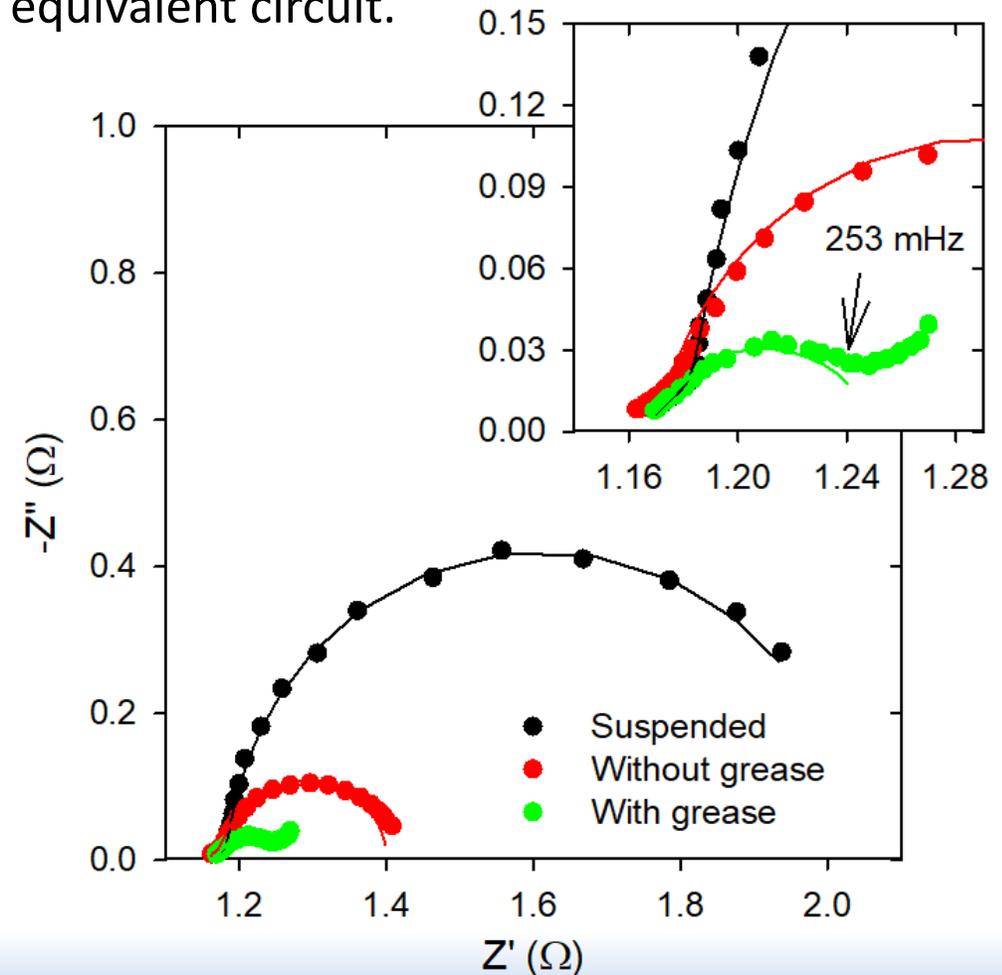
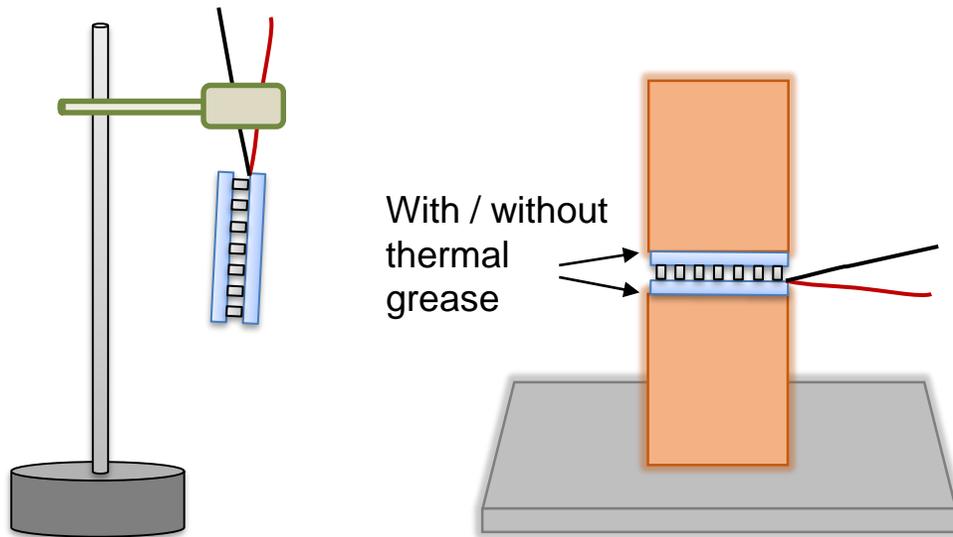
$$Z_{CTC} = \frac{4NS^2 T_{initial} \eta}{\lambda_c \rho_c C_{p,c} A r_{TC} j\omega}$$

$$Z_{WCT,C} = \frac{4NS^2 T_{initial} L_C \eta}{\lambda_c A} \left(\frac{j\omega}{\omega_c} \right)^{-0.5} \tanh \left[\left(\frac{j\omega}{\omega_c} \right)^{0.5} \right]$$

5. Thermal contact resistance determination

Experimental results

The impedance response significantly **changes with the thermal contact resistance value**. Good fittings (lines) to the equivalent circuit.



5. Thermal contact resistance determination

Extracted parameters

The R_{TC} can be obtained from a fitting to the **module in vacuum and in the contacted module setup**.
The **thermal contact resistance** can be obtained from R_{TC} if the **Seebeck coefficient** of the module is **known** ($S=186.42 \mu\text{V/K}$).

	R_{Ω} (Ω)	R_{TE} (Ω)	ω_{TE} (rad s^{-1})	R_C (Ω)	ω_C (rad s^{-1})	R_{TC} (Ω)	r_{TC} ($\text{m}^2\text{mKW}^{-1}$)
Suspended in vacuum	1.16	0.869	0.392	0.0812	5.48	---	---
Without thermal grease	1.15	---	---	---	---	0.259	0.311
With thermal grease	1.16	---	---	---	---	0.012	0.014

The obtained value is **in agreement with literature** results.
Impedance is an **excellent tool to monitor** and evaluate the influence of the **thermal contact**.

6. Acknowledgements

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